

Part Number: 474910001

Product Description: Micro-USB B Receptacle, Mid-

Mount, Matte Tin Plated Shell, Lead-Free

Series Number: 47491

Status: Not Recommended For New Design

Product Category: I/O Connectors



Documents & Resources

Drawings

474910001 sd.pdf

PK-47491-001-001.pdf

3D Models and Design Files

STEP AP242

SOLIDWORKS

Creo

Symbol and Footprint (Multi-Format)

Specifications

PS-47642-001-001.pdf

Product Environment Compliance

Compliance

| GADSL/IMDS | Not Relevant |
|--------------------|---|
| China RoHS | ⊚ per SJ/T 11365-2006 |
| EU ELV | Not Relevant |
| Low-Halogen Status | Low-Halogen per IEC 61249-2-21 |
| REACH SVHC | Not Reviewed per D(2025)4165-DC (25 June 2025) |
| EU RoHS | Compliant per EU 2015/863 |

Compliance Statements

- EU RoHS
- REACH SVHC



• Low-Halogen

Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest

PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

| Status | Not Recommended For New Design |
|----------------|---|
| Category | I/O Connectors |
| Series | 47491 |
| Description | Micro-USB B Receptacle, Mid- Mount, Matte Tin Plated Shell, Lead-Free |
| Application | Wire-to-Board |
| Comments | Signal contacts 1.0A, Power contacts 1.8A |
| Component Type | Receptacle |
| Product Name | USB |
| Standard | USB 2.0 |
| Туре | Micro-B |
| UPC | 822350728454 |

Electrical

| Current - Maximum per Contact | 1.8A, 1.0A |
|-------------------------------|--------------|
| Grounding to Panel | Yes |
| Shielded | Yes |
| Shield Type | Full Shield |
| Voltage - Maximum | 30V AC (RMS) |

Physical

| Circuits (Loaded) | 5 |
|--------------------------------|--------------------------------|
| Circuits (maximum) | 5 |
| Color - Resin | Black |
| Durability (mating cycles max) | 10000 |
| Gender | Female |
| Keying to Mating Part | Yes |
| Lock to Mating Part | No |
| Material - Metal | Copper Alloy |
| Material - Plating Mating | Gold |
| Material - Plating Termination | Gold |
| Material - Resin | High Temperature Thermoplastic |
| Mounting Style | Mid-Mount |
| Net Weight | 0.321/g |
| Number of Rows | 1 |
| Orientation | Right Angle |
| Packaging Type | Embossed Tape on Reel |
| Panel Mount | No |
| PCB Retention | None |
| Pitch - Mating Interface | 0.65mm |
| Pitch - Termination Interface | 0.65mm |
| Polarized to Mating Part | Yes |
| Ports | 1 |
| Temperature Range - Operating | -30° to +85°C |
| Termination Interface Style | Surface Mount |
| Waterproof / Dustproof | No |

Solder Process Data

| Max-Duration | 20 |
|------------------------------|--------|
| Lead-Free Process Capability | REFLOW |
| Max-Cycle | 1 |
| Max-Temp | 245 |